

HD74HC147

10-to-4-line Priority Encoder

REJ03D0572-0200 (Previous ADE-205-446) Rev.2.00 Oct 11, 2005

Description

The HD74HC147 features priority encoding of the inputs to ensure that only the highest order data line is encoded. Nine input lines are encoded to a four line BCD output. The implied decimal zero condition requires no input condition as zero is encoded when all nine data lines are at a high logic level. All data inputs and outputs are active at the low logic level.

Features

High Speed Operation: t_{pd} = 14.5 ns typ (C_L = 50 pF)
 High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$

• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)	
HD74HC147P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_	
HD74HC147FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)	

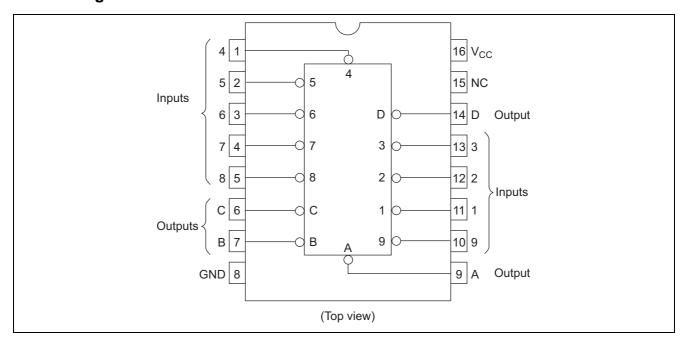
Note: Please consult the sales office for the above package availability.

Function Table

Inputs										Out	puts	
1	2	3	4	5	6	7	8	9	D	С	В	Α
Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
X	Х	Х	Χ	Х	Х	Х	Х	L	L	Н	Н	L
Х	Х	Х	Х	Х	Х	Х	L	Н	L	Н	Н	Н
Х	X	Х	X	Х	Х	L	Н	Н	Н	L	L	L
X	X	Х	X	Х	L	Н	Н	Н	Н	L	L	Н
Х	Х	Х	Х	L	Н	Н	Н	Н	Н	L	Н	L
Х	Х	Х	L	Н	Н	Н	Н	Н	Н	L	Н	Н
Х	Х	L	Н	Н	Н	Н	Н	Н	Н	Н	L	L
Х	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

H: High levelL: Low levelX: Irrelevant

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5 to +7.0	V
Input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Output current	I _{ОUТ}	±25	mA
DC current drain per V _{CC} , GND	I _{CC} , I _{GND}	±50	mA
DC input diode current	I _{IK}	±20	mA
DC output diode current	lok	±20	mA
Power dissipation per package	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time*1	t _r , t _f	0 to 500	ns	V _{CC} = 4.5 V
		0 to 400		$V_{CC} = 6.0 \text{ V}$

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

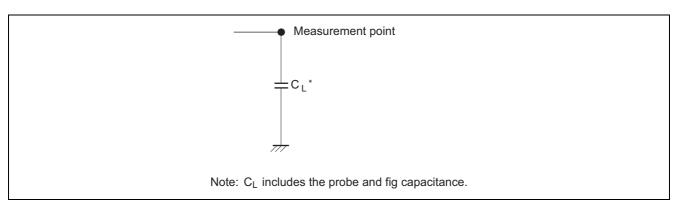
Electrical Characteristics

			Т	a = 25°	С	Ta = -40	to+85°C			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Cor	nditions
Input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	V _{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	_	0.33			I _{OL} = 5.2 mA
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND	
Quiescent supply current	Icc	6.0	_	_	4.0	_	40	μА	Vin = V_{CC} or GND, lout = 0 μ A	

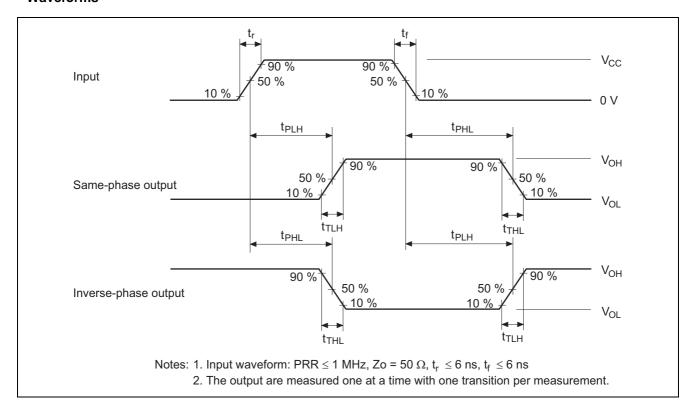
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Т	a = 25°	С	Ta = -40	to +85°C		
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PHL}	2.0	_	_	220	_	275	ns	Select to any Y (4 levels)
time		4.5		15	44	_	55		
		6.0		_	37	_	47		
	t _{PLH}	2.0			220		275	ns	
		4.5		14	44	_	55		
		6.0		_	37	_	47		
Output rise/fall	t _{TLH} , t _{THL}	2.0		_	75	_	95	ns	
time		4.5		5	15	_	19		
		6.0	_	_	13	_	16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

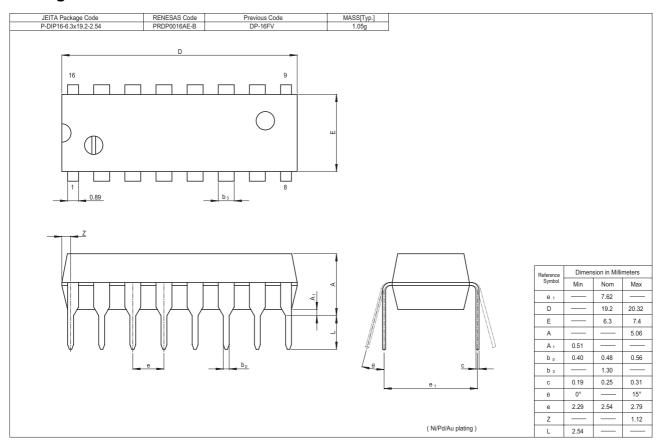
Test Circuit

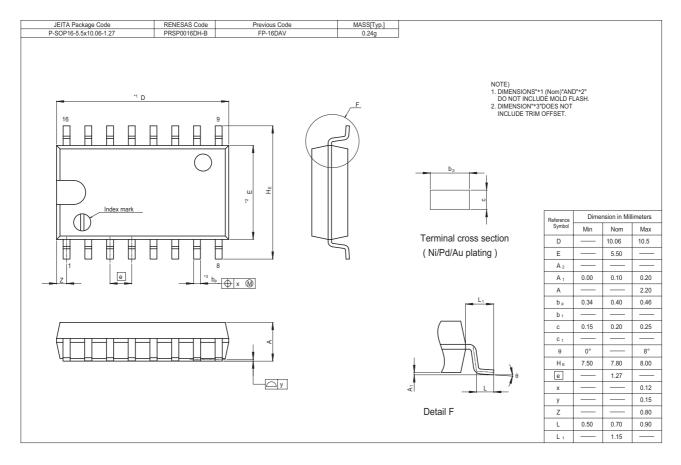


Waveforms



Package Dimensions





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